

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Stefan Bahnmueller</td> <td>10/21/2009</td> </tr> <tr> <td>Stefanie Eiden</td> <td>10/26/2009</td> </tr> <tr> <td>Stephan Michael Meier</td> <td>10/27/2009</td> </tr> <tr> <td>Dirk Storch</td> <td>10/26/2009</td> </tr> <tr> <td>Bernard Dunkel</td> <td>10/26/2009</td> </tr> </tbody> </table>		Name	Execution Date	Stefan Bahnmueller	10/21/2009	Stefanie Eiden	10/26/2009	Stephan Michael Meier	10/27/2009	Dirk Storch	10/26/2009	Bernard Dunkel	10/26/2009
Name	Execution Date												
Stefan Bahnmueller	10/21/2009												
Stefanie Eiden	10/26/2009												
Stephan Michael Meier	10/27/2009												
Dirk Storch	10/26/2009												
Bernard Dunkel	10/26/2009												
RECEIVING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>Bayer MaterialScience AG</td> </tr> <tr> <td>Street Address:</td> <td>Q18</td> </tr> <tr> <td>City:</td> <td>Leverkkusen</td> </tr> <tr> <td>State/Country:</td> <td>GERMANY</td> </tr> <tr> <td>Postal Code:</td> <td>51368</td> </tr> </table>		Name:	Bayer MaterialScience AG	Street Address:	Q18	City:	Leverkkusen	State/Country:	GERMANY	Postal Code:	51368		
Name:	Bayer MaterialScience AG												
Street Address:	Q18												
City:	Leverkkusen												
State/Country:	GERMANY												
Postal Code:	51368												
PROPERTY NUMBERS Total: 1													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 30%;">Property Type</th> <th style="width: 70%;">Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12466636</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	12466636								
Property Type	Number												
Application Number:	12466636												
CORRESPONDENCE DATA													
<p>Fax Number: (302)658-5614 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 3026589141 Email: LFerry@cblh.com Correspondent Name: Aaron R. Ettelman Address Line 1: Connolly Bove Lodge & Hutz LLP Address Line 2: 1007 North Orange Street Address Line 4: Wilmington, DELAWARE 19801</p>													
ATTORNEY DOCKET NUMBER:	14069*262 (BMS 07 1 132)												
NAME OF SUBMITTER:	Aaron R. Ettelman												

OP \$40.00 12466636

501003811

PATENT
REEL: 023455 FRAME: 0551

Total Attachments: 3

source=Assignment#page1.tif

source=Assignment#page2.tif

source=Assignment#page3.tif

Assignment

For valuable consideration, the receipt and adequacy of which is hereby acknowledged,

We,

1. Dr. Stefan BAHNMÜLLER, 63 Chulia Street OCBC Centre E, 049514 Singapur, SG
2. Dr. Stefanie EIDEN, Heinrich-Böll-Str. 42, 51371 Leverkusen, DE
3. Dr. Stephan Michael MEIER, Friedensstr. 14, 41517 Grevenbroich, DE
4. Dirk STORCH, Domagk str. 14, 51063 Köln, DE
5. Bernard DUNKEL, Piet-Mondrian-Str.73, 51375 Leverkusen, DE

hereby sell, assign, and transfer unto BAYER MATERIALSCIENCE AG a corporation of DE, located at 51368 Leverkusen, DE the entire right, title, and interest in and to our application for Letters Patent of the United States, entitled

USSN: 12/466,636

Filing date: May 15, 2009

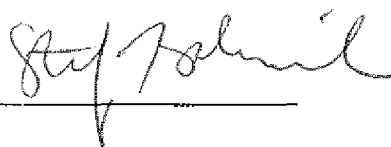
Printable Compositions Containing Silver Nanoparticles, Processes for Producing Electrically Conductive Coatings Using the Same, and Coatings Prepared Thereby

and our entire right, title, and interest in and to all our inventions, whether joint or sole, disclosed in said application for Letters Patent, and in and to all divisional or continuation applications that may be filed for United States Letters Patent for any of said inventions, and in and to all patents that may be granted on the foregoing applications, and we hereby agree, whenever requested, to communicate to said assignee, its successors and assigns, any facts known to us respecting said inventions and to execute all applications or papers necessary to obtain and maintain proper patent protection on said inventions in the United States.

Date/Datum

Inventors/Erfinder

21.10.2009

1. 

2. _____

BMS071132 - US

PATENT

REEL: 023455 FRAME: 0553

Assignment

For valuable consideration, the receipt and adequacy of which is hereby acknowledged,

We,

1. Dr. Stefan BAHNMÜLLER, 63 Chulia Street OCBC Centre E, 049514 Singapur, SG
2. Dr. Stefanie EIDEN, Heinrich-Böll-Str. 42, 51371 Leverkusen, DE
3. Dr. Stephan Michael MEIER, Friedensstr. 14, 41517 Grevenbroich, DE
4. Dirk STORCH, Domagk str. 14, 51063 Köln, DE
5. Bernard DUNKEL, Piet-Mondrian-Str.73, 51375 Leverkusen, DE

hereby sell, assign, and transfer unto BAYER MATERIALSCIENCE AG a corporation of DE, located at 51368 Leverkusen, DE the entire right, title, and interest in and to our application for Letters Patent of the United States, entitled

USSN: 12/466,636

Filing date: May 15, 2009

Printable Compositions Containing Silver Nanoparticles, Processes for Producing Electrically Conductive Coatings Using the Same, and Coatings Prepared Thereby

and our entire right, title, and interest in and to all our inventions, whether joint or sole, disclosed in said application for Letters Patent, and in and to all divisional or continuation applications that may be filed for United States Letters Patent for any of said inventions, and in and to all patents that may be granted on the foregoing applications, and we hereby agree, whenever requested, to communicate to said assignee, its successors and assigns, any facts known to us respecting said inventions and to execute all applications or papers necessary to obtain and maintain proper patent protection on said inventions in the United States.

Date/Datum

Inventors/Erfinder

26.10.09

1. _____
2. S. Eiden

BMS071132 - US

PATENT
REEL: 023455 FRAME: 0554

27.10.2008

26.10.2008

26.10.2009

3. S. Lee

4. Dirk Hardy

5. Bernard Dunkel